# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





#### Features

- 0402 0.45mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

# Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

#### Description

The IN-S42AT series is a popular low profile 0402 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

#### **Recommended Solder Pattern**

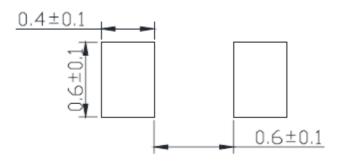
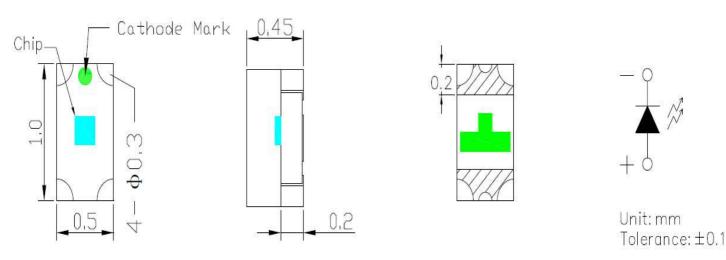


Figure 1. IN-S42AT Solder Pattern



# Package Dimensions in mm

Figure 2. IN-S42AT Package Dimensions



#### Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	Top (°C)	Тѕт (⁰С)
IN-S42ATYG	Yellow Green	78	25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATY	Yellow	78	25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATA	S42ATA Amber		25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATR	Red	78	25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATB	Blue	100	25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATG	Green	100	25	100	5	-30°C~+80°C	-40°C~+85°C
IN-S42ATUW	White	100	25	100	5	-30°C~+80°C	-40°C~+85°C

#### Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



## **Electrical Characteristics** T<sub>A</sub> = 25°C (Note 1)

	Emission		VF(V)			λ(nm)		Viewing Angle	l <sup>*</sup> ∨(mcd)
Product	Color	I <sub>F</sub> (mA)	typ.	max	λD	λP	∆∆	<b>2</b> <i>θ</i> 1/2	typ.
IN-S42ATYG	Yellow Green	20	1.9	2.6	572	575	-	130	28.5
IN-S42ATY	Yellow	20	2.0	2.6	592	593	-	130	145
IN-S42ATA	Amber	20	2.1	2.6	605	610	-	130	145
IN-S42ATR	Red	20	2.1	2.6	631	645	-	130	90
IN-S42ATB	Blue	20	3.1	4.0	470	468	-	120	100
IN-S42ATG	Green	20	3.3	4.0	525	523	-	130	450
IN-S42ATUW	White	20	3.1	4.0	X=0.295 Y=0.30	-	-	130	600

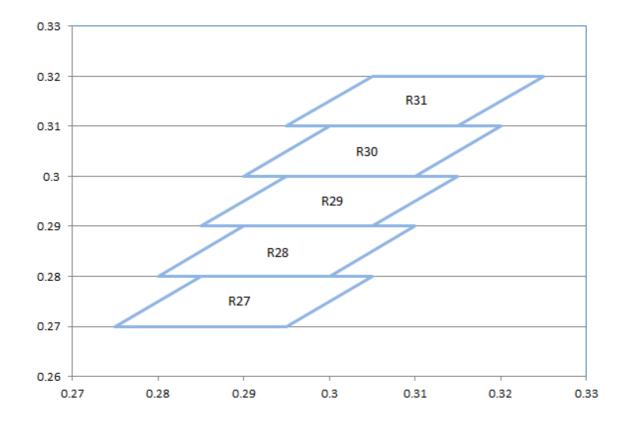
#### Notes

1. Performance guaranteed only under conditions listed in above tables.

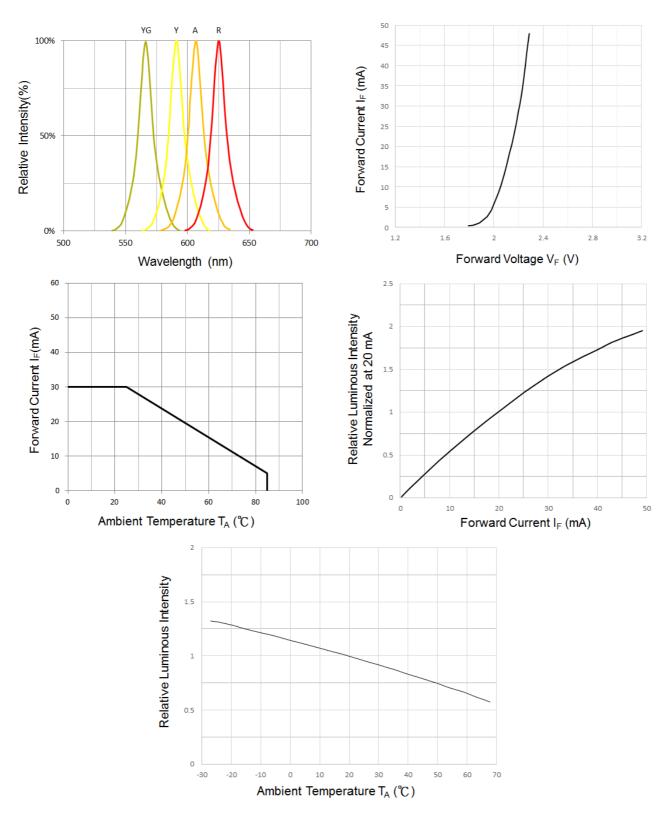


# Chromaticity Bin (for White only)

BIN	CIE	Тор	Right	Bottom	Left	BIN	CIE	Тор	Right	Bottom	Left
<b>D</b> 07	Х	0.275	0.285	0.305	05 0.295 R28	Х	0.28	0.29	0.31	0.3	
R27	Y	0.27	0.28	0.28	0.27	K20	Y	0.28	0.29	0.29	0.28
R29	Х	0.285	0.295	0.315	0.305	R30	Х	0.29	0.3	0.32	0.31
K29	Y	0.29	0.3	0.3	0.29		Y	0.3	0.31	0.31	0.3
D21	Х	0.295	0.305	0.325	0.315						
R31	Y	0.31	0.32	0.32	0.31						



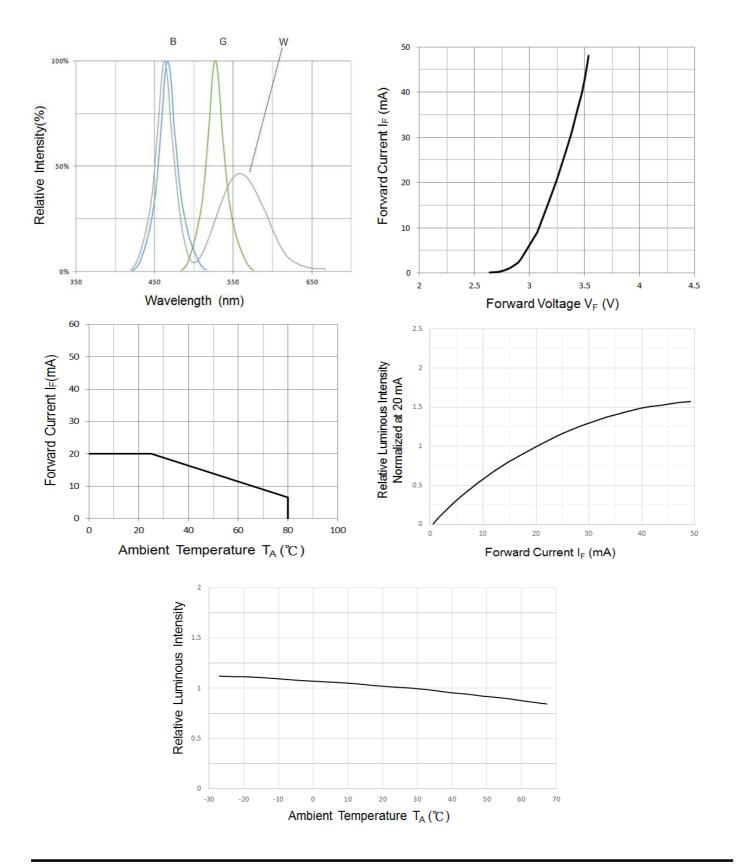




# Typical Characteristic Curves – YG, Y, A, R

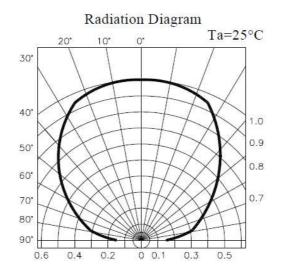


# Typical Characteristic Curves – B, G, W





### **Typical Characteristic Curves – Radiation Pattern**

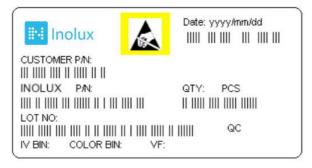


# **Ordering Information**

Product	Emission Color	Technolog y	Test Current I <sub>F</sub> (mA)	Luminous Intensity I <sub>V</sub> (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-S42ATYG	Yellow Green	AllnGaP	20	36	1.9	IN-S42ATYG
IN-S42ATY	Yellow	AllnGaP	20	90	2.0	IN-S42ATY
IN-S42ATA	Amber	AllnGaP	20	90	2.1	IN-S42ATA
IN-S42ATR	Red	AllnGaP	20	90	2.1	IN-S42ATR
IN-S42ATB	Blue	InGaN	20	100	3.1	IN-S42ATB
IN-S42ATG	Green	InGaN	20	360	3.3	IN-S42ATG
IN-S42ATUW	White	InGaN	20	600	3.1	IN-S42ATUW



#### **Label Specifications**



#### Inolux P/N:

I	Ν	-	S	4	2	А	Т			Х	-	Х	х	х	Х
			Material	Package Variation		Orientation	Current	Lens	Color				omiz 1p-o		
	olux MD		S = PCB Type	42	2A = 1.0 0.45r	) x 0.5 x nm	T = Top Mount	(Blank) = 20mA 5=5mA	(Blank) = Clear U = Diffused	R=645m A=610nm Y=593nm YG=575nm G=523nm B=468nm W=White					

#### Lot No.:

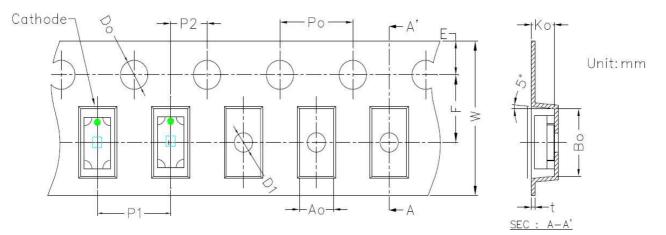
Z	2	2 0 1 7				01 24	
Internal Tracker		Year (2017	, 2018,)		Month	Date	Serial



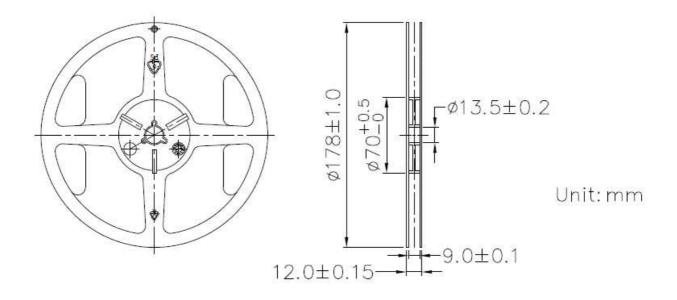
### Packaging Information: 5000pcs Per Reel

# Tape Dimension

	Packing Size												
Item	W	P1	E	F	Do	D1	Po	10Po	P2	Ao	Во	Ko	Т
Spec.	8.00	4.00	1.75	3.50	1.55	0.40	4.00	40.00	2.00	0.57	1.12	0.55	0.20
Tolerance	+0.30 -0.10	±0.10	±0.10	±0.05	±0.05	±0.1	±0.1	±0.20	±0.05	±0.03	±0.03	±0.03	±0.05

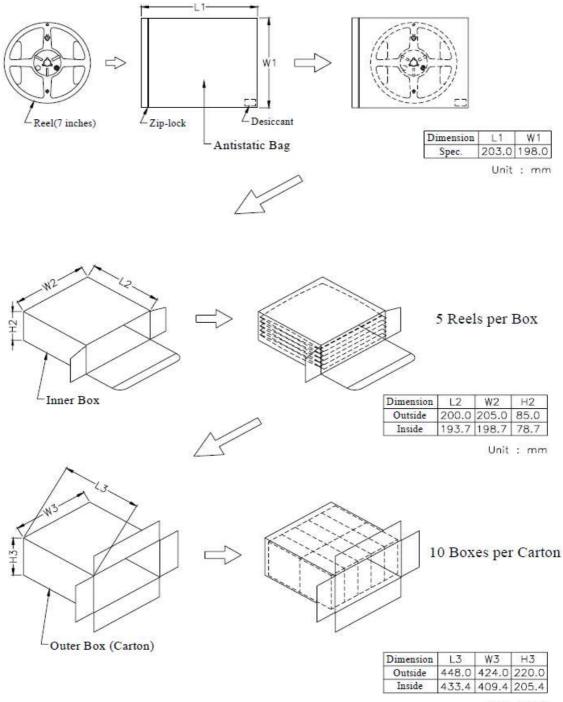


#### **Reel Dimension**





### **Packing Dimension**



Unit : mm

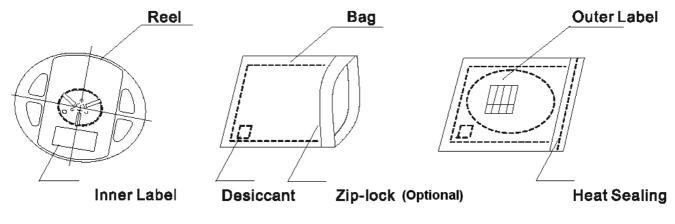


#### Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

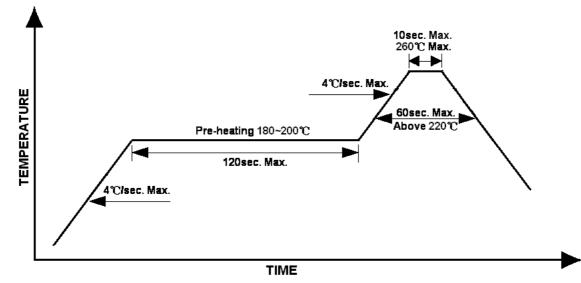
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



#### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



#### Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

#### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



#### Reliability

Item		Standards	Conditions
nem	failures	Reference	
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
bias			IF=20mA
			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 $\mu$ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
Temperature		IEC 68-2-14, Nb	15min
cycle			Thermal steady within 5 min
oyolo			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



#### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-07-2017
Format Update		1.1	04-25-2017

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.